

Single P-channel MOSFET

ELM13409CA-S

■ General description

ELM13409CA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■ Features

- $V_{ds} = -30V$
- $I_d = -2.6A$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 130m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 200m\Omega$ ($V_{gs} = -4.5V$)

■ Maximum absolute ratings

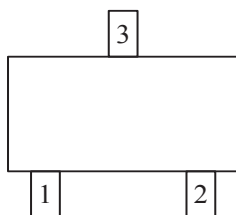
Parameter	Symbol	Limit	Unit	Note	
Drain-source voltage	V_{ds}	-30	V		
Gate-source voltage	V_{gs}	± 20	V		
Continuous drain current	I_d	$T_a = 25^\circ C$	-2.6	A	1
		$T_a = 70^\circ C$	-2.2		
Pulsed drain current	I_{dm}	-20	A	2	
Power dissipation	P_d	$T_a = 25^\circ C$	1.4	W	1
		$T_a = 70^\circ C$	1.0		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	$^\circ C$		

■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	70	90	$^\circ C/W$	1
Maximum junction-to-ambient	Steady-state		100	125	$^\circ C/W$	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	63	80	$^\circ C/W$	3

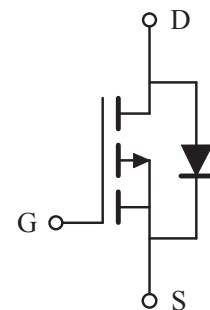
■ Pin configuration

SOT-23(TOP VIEW)



Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN

■ Circuit



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■ Electrical characteristics

Ta=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	Id=-250μA, Vgs=0V	-30			V
Zero gate voltage drain current	Idss	Vds=-24V			-1	μA
		Vgs=0V	Tj=55°C		-5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250μA	-1.0	-1.9	-3.0	V
On state drain current	Id(on)	Vgs=-4.5V, Vds=-5V	-5			A
Static drain-source on-resistance	Rds(on)	Vgs=-10V		97	130	mΩ
		Id=-2.6A	Tj=125°C	135	150	
		Vgs=-4.5V, Id=-2A		166	200	mΩ
Forward transconductance	Gfs	Vds=-5V, Id=-2.5A	3.0	3.8		S
Diode forward voltage	Vsd	Is=-1A, Vgs=0V		-0.82	-1.00	V
Max. body-diode continuous current	Is				-2	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss			302.0	370.0	pF
Output capacitance	Coss	Vgs=0V, Vds=-15V, f=1MHz		50.3		pF
Reverse transfer capacitance	Crss			37.8		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		12	18	Ω
SWITCHING PARAMETERS						
Total gate charge (10V)	Qg			6.80	9.00	nC
Total gate charge (4.5V)	Qg	Vgs=-10V, Vds=-15V		2.40		nC
Gate-source charge	Qgs	Id=-2.6A		1.60		nC
Gate-drain charge	Qgd			0.95		nC
Turn-on delay time	td(on)			7.5		ns
Turn-on rise time	tr	Vgs=-10V, Vds=-15V		3.2		ns
Turn-off delay time	td(off)	RI=5.8Ω, Rgen=3Ω		17.0		ns
Turn-off fall time	tf			6.8		ns
Body diode reverse recovery time	trr			16.8	22.0	ns
Body diode reverse recovery charge	Qrr	If=-2.6A, dl/dt=100A/μs		10.0		nC

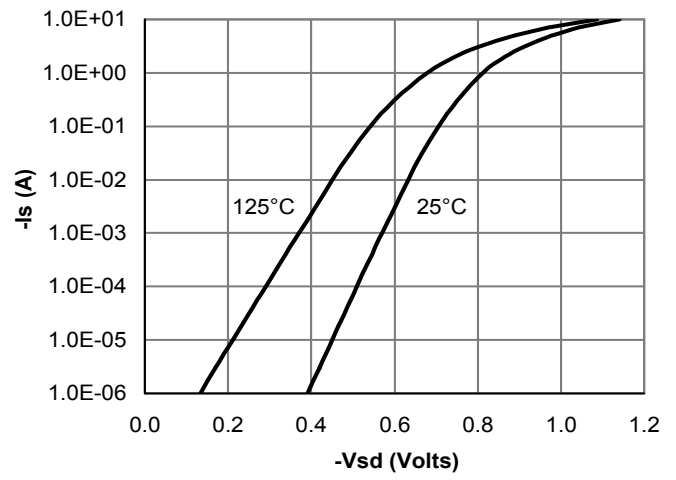
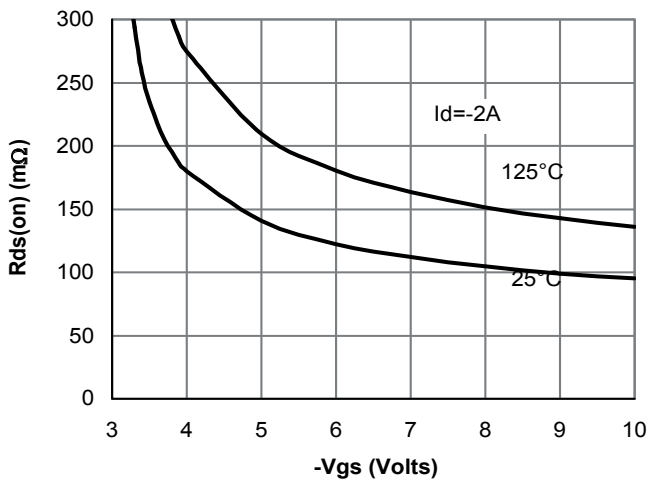
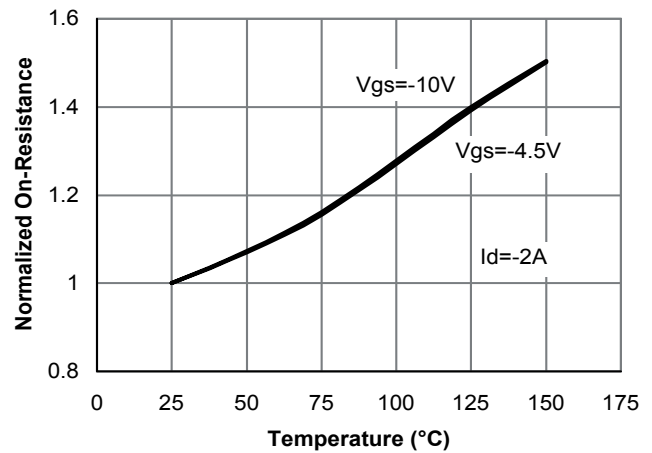
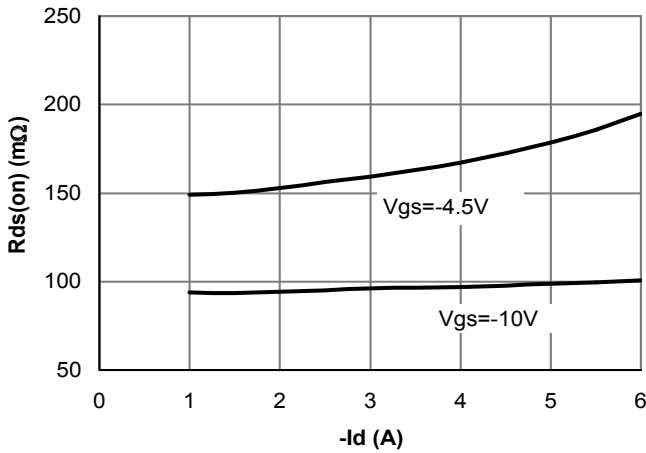
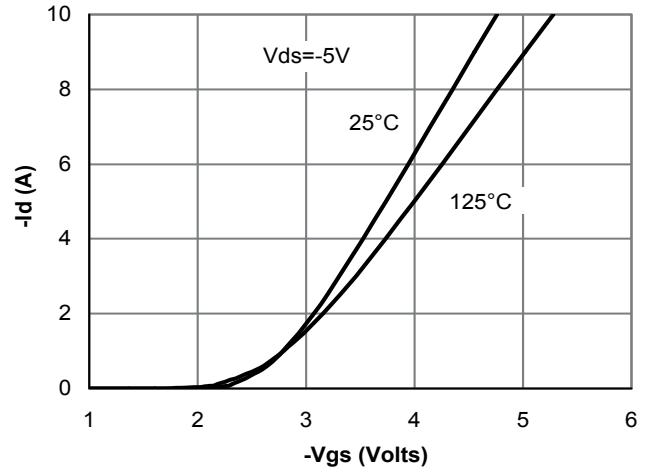
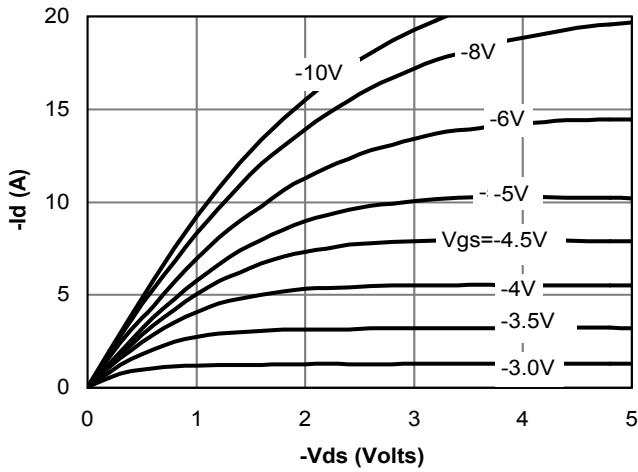
NOTE :

1. The value of Rθja is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The Rθja is the sum of the thermal impedance from junction to lead Rθjl and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics



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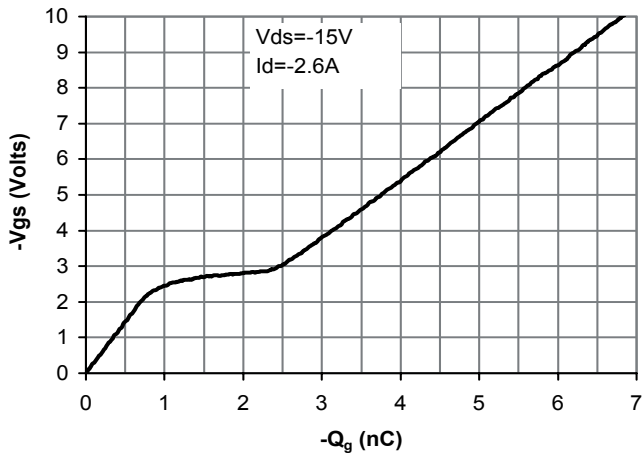


Figure 7: Gate-Charge Characteristics

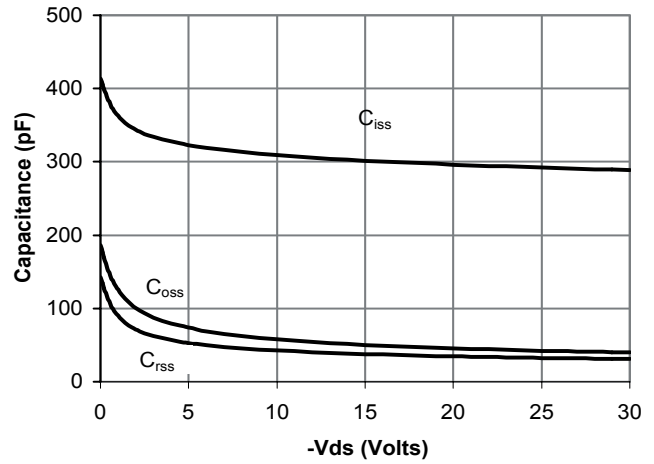


Figure 8: Capacitance Characteristics

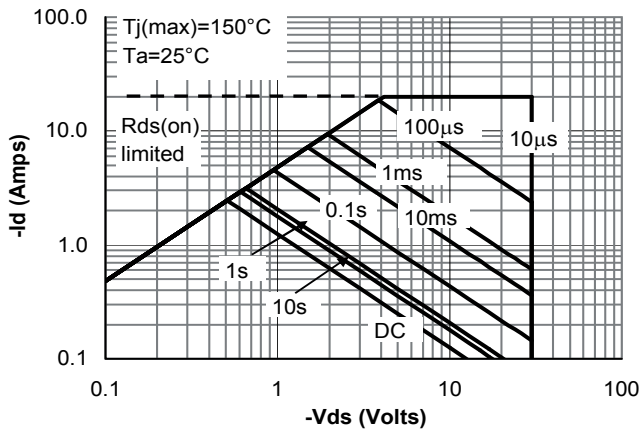


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

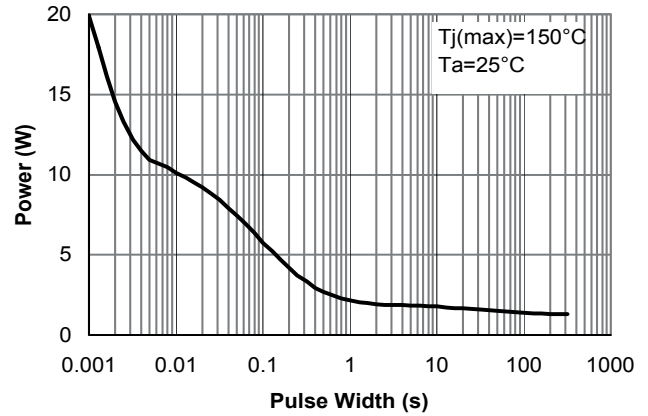


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

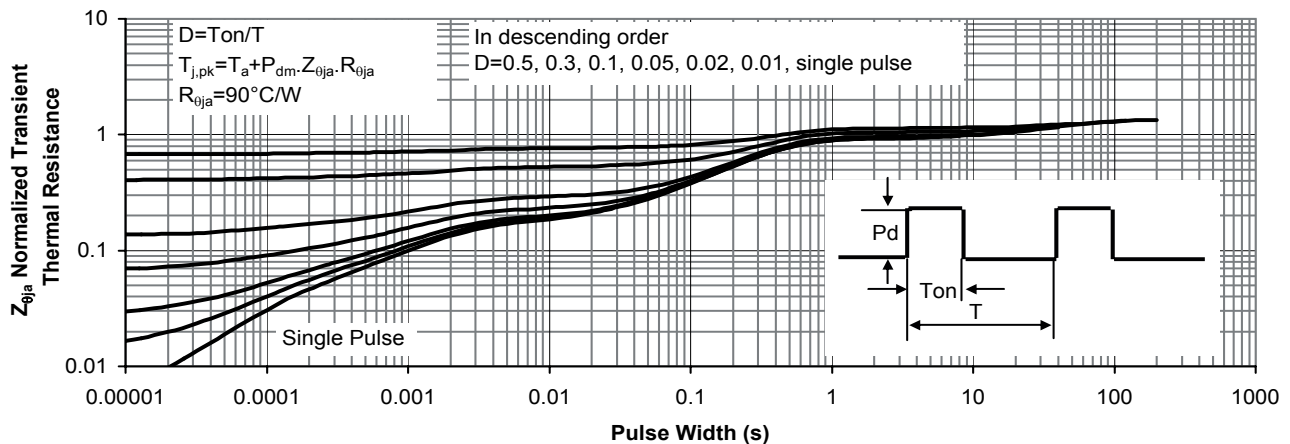


Figure 11: Normalized Maximum Transient Thermal Impedance